



經濟部

Ministry of Economic Affairs

經濟部產業發展署

Industrial Development Administration, MOEA

太空產業供應鏈暨網通產業新星飛揚計畫

The Plan for Space Industry Supply Chain Development
and Communications Industry Talent Empowerment

大專校院學生選送及專題輔導


Selection and Program Guidance for Universities & Students

113 年度申請須知

2024 Application Guide

主辦單位： 經濟部產業發展署

Organizer: Industrial Development Administration, MOEA

執行單位： 台北市電腦商業同業公會

Implementer: Taipei Computer Association

中華民國 113 年 2 月

February, 2024

目錄

Table of Contents

一、計畫說明 Program Scheme	1	
二、執行期間 Program Period.....	3	
三、申請資格 Eligibility.....	3	
四、申請方式 Application.....	5	
五、學生甄選作業 Selection.....	7	
六、配合事項 Items for Coordination.....	7	
七、計畫重要時程 Program Timeline.....	12	
八、計畫執行團隊聯絡窗口 Program Office Contact Information.....	12	
<table border="1"><tr><td>附件一、申請履歷資料</td></tr></table>	附件一、申請履歷資料	14
附件一、申請履歷資料		
<table border="1"><tr><td>Attachment 1 Application Form</td></tr></table>	Attachment 1 Application Form	14
Attachment 1 Application Form		

一、計畫說明 Program Scheme

本計畫透過與產、學、研或公協會等合作，以「產業出題，人才實戰」方式，引導產業就商用 5G 產品、衛星地面終端、太空（衛星）相關研發產品提出專題，推動國內大專校院在學生及應屆畢業生參與產業研發出題，居間協助產業媒合、養成學生具技術知識與研發實戰能力，並辦理技術工作坊及國際培育營等活動，加速人才養成。參考領域包括：

This initiative aims to team up with industry, academia, research institutions, and public associations to foster a collaborative environment where industries propose challenges in the fields of commercial 5G products, satellite ground terminals, and space (satellite)-related research and development projects. The approach is centered around the motto "Industry Leads, Talent Engages," encouraging active participation of students from domestic universities in tackling these challenges. By facilitating industry-academia partnerships, we aim to facilitate matchmaking, equip students with technical know-how, and hone their practical R&D skills. Furthermore, we organize technical workshops and international training camps to accelerate talent development. The referenced fields include:

類別 Category	參考領域 Fields	說明 Description
5G / 3GPP R15 以上 5G/3GPP Release 15 and Beyond	開放網路 Open Radio Access Network (O-RAN)	導入開放網路架構開發之相關產品，如基站(O-CU、O-DU、O-RU)、管理(SMO、RIC)、核網(5GC、RIC 網管)、端到端解決方案等。 Products developed on O-RAN, including base stations (O-CU, O-DU, O-RU), management tools (SMO, RIC), core network components (5GC, RAN Intelligent Controller), and end-to-end solutions, etc.
	系統整合 System Integration	如基站設備的設計、製造及軟體整合、異質網路整合等。 Including the design, manufacturing, and software integration of base station equipment, heterogeneous network integration, etc.

	專網終端設備 Private 5G Networks Terminal Equipment	如 5G AMR (無人搬運車)、5G 投影機、5G 監控射影機等。 Including 5G Autonomous Mobile Robot (AMR), 5G projectors, 5G surveillance cameras, etc.
	元件/傳輸 Components/transmission	如天線、射頻、小基站無線接取、關鍵材料、SDN/NFV 解決方案等。 Including antennas, radio frequency (RF), small cell radio access network, key materials, SDN/NFV solutions, etc.
	應用 Application	如車聯網 / 自動駕駛、5G 智慧物聯網(5G AIoT)、工業物聯網等應用。 Including Internet of vehicles (IoV) / Autonomous Vehicle, 5G Artificial Intelligence of Things (5G AIoT), Industrial Internet of Things (IIoT), etc.
太空/ 低軌道 衛星 Space / LEO Satellite	關鍵零組件 Key Components	如高頻/高速基板(基材)、基頻晶片、波束成形晶片、射頻(如微波/毫米波)相關材料/元件與模組、構裝/製程材料、天線單元材料等。 Including high-frequency/high-speed substrates, baseband chips, beamforming chips, RF (such as microwave / millimeter wave) related materials / components and modules, assembly / process materials, antenna unit materials, etc.
	次系統 Subsystems	如天線次系統及室內外設備連結次系統。 Including antenna subsystems and connections for indoor and outdoor equipment subsystems. 1. 天線次系統：如相位陣列天線(如液晶天線等)、碟型天線、多輸入多輸出系統、天線封裝/模組技術、天線控制單元等。 Antenna subsystem: phased array antennas (liquid crystal antennas), dish antennas, multi-input multi-output (MIMO) systems, Antenna-in-Package (AiP) / module technology, antenna control units, etc. 2. 室內外設備連結次系統：如連接器、電源供應器、路由器/數據機等。 Connections for indoor and outdoor equipment subsystems: connectors, power supplies, routers/modems, etc.

	系統整合終端 System Integrated Terminal	如用戶終端、地面接收站、衛星遙傳追蹤指令站等。 Including user terminals, ground receiver stations, satellite telemetry, tracking and command stations, etc.
	其他 Others	如衛星本體元件、衛星地面設備檢測及創新應用（如家用、車用、航空、海事或其他衛星相關服務）等。 Including satellite bus components, satellite ground equipment testing or innovation applications (such as for household, automotive, aviation, maritime, or other satellite-related services), etc.

二、執行期間 Program Period

研發實戰推動期程：自 113 年 7 月 1 日至 113 年 9 月 30 日止。

Research and development internship period: July 1st to September 30th, 2024.

三、申請資格 Eligibility

(一) 學校資格 Eligibility for University as Recommender

教育部核定之中華民國公私立大專校院（以下簡稱大專校院）得推薦與確認大三（含）以上及碩士（含博士）在學生申請本計畫，並請協助受推薦之僑外生申請工作許可證。

A university recommender must meet all of the following criteria:

1. is an MOE approved college or university located in Taiwan R.O.C.;
2. can recommend students from both undergraduate programs (juniors and above) and graduate programs;
3. can assist international and overseas Chinese students in applying for work permit.

(二) 學生資格 Eligibility for Student Applicant

1. 本國生 Domestic student

- (1) 應具備中華民國國籍。
- (2) 在學一般生：113 學年度第一學期就讀於我國大專校院、不限科系之大三以上學士、碩士及博士在學生，不含在職生。
- (3) 應屆畢業生：112 學年度畢業，且於 113 年 8 月 31 日前取得畢業證書者（男性須為役畢或符合免役資格），不含在職生。

An applicant must meet at least two of the following criteria:

1. must hold Taiwan (R.O.C.) citizenship;
2. is student in the third year of study or higher (including Masters and PhD) in fall semester 2024 (excluding in-service students); no specific major requirement;
3. graduate of 2024, and must obtain graduation certificate by August 31, 2024 (male students must have completed military service or meet exemption criteria), excluding in-service students.

2. 僑外生 Overseas Chinese and International Student

- (1) 具備外籍生或僑生身分並持有外僑居留證者，不包含陸、港、澳生。
- (2) 於申請計畫至參與計畫期間，保持在學學生身分，並於 113 學年度第一學期就讀於我國大專校院、不限科系之大三以上學士、碩士及博士在學生，不含在職生。
- (3) 經錄取之學生須於 113 年 7 月 1 日至 9 月 30 日持有有效工作許可證。工作許可申請方式依各校規定辦理，請洽各校僑外生事務窗口。

An applicant must meet all of the following criteria:

1. is an international or overseas Chinese student who holds valid Alien Resident Card (ARC);

*Mainland China, Hong Kong and Macao students are not eligible

for this program.

2. must maintain full-time student status from the time of application to participation in the program;
3. is student in the third year of study or higher (including Masters and PhD) in fall semester 2024 (excluding in-service students); no specific major requirement;
4. must hold a valid work permit from July 1st to September 30th, 2024.

The application process for work permits should be in accordance with the regulations of each university. Please contact the international student affairs office of each university for details.

四、申請方式 Application

各校有意參加本計畫之學生，自行上傳相關履歷資料。由學校統一窗口確認最終推薦名單。

Applicants must complete application form and submit personal resume on the application portal; the final list of recommendation will be confirmed by the university's designated office.

(一) 學生網路報名：Student Application

- 各校有意參加本計畫之學生，須於 **113 年 5 月 8 日 (三)** 前於本計畫網站填報報名表及自行上傳相關履歷資料。

Applicants must complete application form and submit relevant documents on the application portal before May 8th, 2024.

- 申請網址：Application portals

5G/ 3GPP R15 以上：<https://www.5g-jump.org.tw/>

5G / 3GPP R15 and Beyond: <https://www.5g-jump.org.tw/>

太空/低軌道衛星：<https://www.satcom.org.tw/>

Space / Leo Satellite: <https://www.satcom.org.tw/>

- 逾時、資料不全或資格不符者，均不予受理。

Applications that are overdue, incomplete, or do not meet the qualifications will not be processed.

(二) 各校確認推薦名單：University Recommenders

- 由學校統一窗口（建議由一級單位擔任）於 **113年5月9日（四）~113年5月13日（一）**，至本計畫網站報名/媒合系統確認最終推薦名單。

University as Recommenders must confirm the final list of recommendation on the portals from May 9th (Thursday) to May 13th (Monday), 2024.

- 報名/媒合系統之帳號與使用方式，將由計畫執行團隊另行通知學校統一窗口。

The account credentials and instructions for the application/matching systems will be communicated separately at a later date.

五、學生甄選作業 Selection

甄選流程 Process	流程說明 Details
<pre> graph TD A[1. 學生填報履歷 Application Submission] --> B[2. 各校確認學生推薦名單 University Recommendation] B --> C[3. 面談/媒合/遞補 Interview/Matching/Alternate Selection] C --> D[4. 辦理報到及提交錄取名單 Admission Result Submission] D --> E[5. 公告錄取名單 Admission Announcement] </pre>	<ol style="list-style-type: none"> 1. 有意參加本計畫之學生，於 113年5月8日（三）前至計畫網站（網址：https://www.satcom.org.tw/）自行填報及上傳履歷資料。Applicants complete and submit applications online before May 8th, 2024. 2. 由學校統一窗口確認最終推薦名單，於 113年5月9日（四）~113年5月13日（一）於報名/媒合系統（請洽計畫執行團隊）確認送出。Universities as Recommender confirm the final list of recommendation before May 13th, 2024. 3. 113年5月14日（二）~113年6月21日（五）由企業履歷媒合、學生主動應徵職缺；企業、大專校院學生進行面談及媒合。Enterprises resume matching and interview applicants from May 14th to June 21st, 2024. 4. 113年6月26日（三）前，由企業通知學生完成報到相關手續，並提交錄取名單。Accepted students confirm admission and enterprises submit admission results before June 26, 2024. 5. 113年6月底前，本計畫網站（網址：https://www.satcom.org.tw/）公告錄取名單。Program Office announces the final admission list by the end of June, 2024.

※以上為暫定時程，屆時將依實際情況調整。The above schedule is tentative and may be adjusted according to actual circumstances.

六、配合事項 Items for Coordination

(一) 大專校院 For Universities

1. 建議由大專校院的一級單位擔任統一窗口。

It is recommended that the primary unit of universities or colleges serve as the central coordinating office.

2. 建議大專校院授與本計畫錄取學生相對等之實習學分。

It is recommended that universities grant equivalent internship credits to students admitted to this program.

3. 進行校內甄選作業並推薦本國籍應屆畢業生及大三（含）以上之在學一般生申請；僑外（不含陸、港、澳生）大三（含）以上之在學一般生申請（不含應屆畢業生）。

Universities are to conduct internal selection procedures and recommend domestic students who are final semester students and students in their third year of study or higher to apply. For overseas Chinese and international students (excluding those from mainland China, Hong Kong, and Macau), students in their third year of study or higher are eligible to apply (excluding final semester students).

4. 參與本計畫舉辦之活動，如人才媒合、研發專題發表等，並藉此展示學生參與專題成果，做為學校招生行銷與曝光之管道。

It is encouraged for the universities engage in events hosted by this program, such as talent networking and research projects presentations, to promote and enhance the visibility for the universities.

5. 協助本計畫錄取之僑外生辦理工作許可證。

Assist overseas Chinese and International students admitted to this program to obtain work permits.

(二) 學生 For Students

1. 研發實戰實作及培訓 Training and Internship

- (1) 每位學生以媒合一家企業之一項領域或研發專題為限。

Each student is restricted to being matched with one enterprise in a particular field or research project

- (2) 學生研發實戰總時數至少須達 196 小時，全程（3 個月）的每個月都需有研發實戰時數，且須於計畫系統填報參與企業研發實戰及學習活動等相關紀錄。

Each student must complete a minimum of 196 hours of internship. Throughout the entire three-month duration, students are expected to participate in research and development activities every month. Additionally, students must record their involvement in the projects and learning activities in the program system.

- (3) 參與計畫舉辦的學習活動，如技術工作坊、國際培育營等，並填寫滿意度問卷。

Students are expected to take part in learning activities organized by the Program Office, such as technical workshops and international training camps, and provide feedback through satisfaction surveys.

- (4) 須配合計畫期末辦理之研發實戰發表暨媒合交流活動，展示研發實戰成果。

Students are required to participate in the end-of-program presentation and networking event, where they will showcase the project outcomes.

- (5) 本計畫提供國內外研習機會，相關作業辦法預計 9 月於官網公告。

This program offers study trip both domestically and internationally. Details regarding the application process are anticipated to be announced on the official website in September, 2024.

2. 研發實戰津貼 Stipend

企業錄取之學生自 **113 年 7 月 1 日至 113 年 9 月 30 日止(共 3 個月整)**，研發實戰總時數至少須達 196 小時，全程（3 個月）的每個月都需有研發實戰時數。本計畫給付每人總津貼，學士級為總津貼新臺幣 36,000 元整；碩士級以上（含博士）總津貼新臺幣 60,000 元整，其他相關薪資福利由企業自行與所錄取的學生議定之。

Selected students will be engaged from July 1st to September 30th, 2024, spanning a total of 3 months. During this period, they are required to

accumulate a minimum of 196 hours of research and development projects, with activities scheduled each month. Students in the program will receive a total stipend of NT\$36,000 for bachelor's degree level participants and NT\$60,000 for master's degree level and above (including doctoral) participants. Any additional salary benefits will be determined through negotiation between enterprises and the selected students.

項目 Item	碩士級以上 (含博士) (每人總津貼) Master's and above	學士級 (每人總津貼) Bachelor's
實戰津貼 Total Stipend	60,000 元 NT\$60,000	36,000 元 NT\$36,000

註：(1)參考經濟部產業發展署「太空產業供應鏈發展推動計畫」112年「企業申請須知」和112年「大專校院太空菁英選送及研發實戰輔導申請須知」。

The regulations are in accordance with the 2023 Application Guides.

(2)保險費：依勞工保險條例及全民健康保險法之規定辦理勞工保險及全民健康保險之雇主應負擔部分，費用編列基準依勞動部勞工保險局及衛生福利部中央健康保險署規定辦理。

Insurance Fees: The employer's contribution to labor insurance and national health insurance premiums are processed according to the regulations outlined in the Labor Insurance Act and the National Health Insurance Act. The fee allocation criteria are determined in accordance with the guidelines provided by the Bureau of Labor Insurance, Ministry of Labor and the National Health Insurance Administration, Ministry of Health and Welfare.

3. 追蹤調查 Career Development Survey

須配合本計畫執行結訓追蹤調查作業至少2年，且須告知就業公司、職稱、工作內容與薪資等資訊。

Students are expected to participate in the career development survey for a minimum of 2 years, and must disclose information regarding their employing company, job title, responsibilities, and salary.

4. 研發實戰中止作業 Termination and Withdrawal

- (1) 學生得因不可抗力之因素，並提出相關證明（例如：診斷書等資料），向企業申請研發實戰終止，無須償還已請領之研發實戰津貼，但涉及後項規定除外。

Students may terminate the program with a company due to uncontrollable circumstances, provided they submit relevant documentation (such as a medical diagnosis). In such cases, they will not be required to repay any stipend already received, unless otherwise specified.

- (2) 學生有以下情形將予以研發實戰終止：

Program will be terminated if the students:

- A. 個人報名及履歷資料填寫不實者，須繳回已請領之津貼予公司，並不得再申請本計畫。

provide false information during application and resume submission; in such cases, they must return any stipends received to the company and will not be eligible to reapply for the program.

- B. 因學生適應不佳，由企業向本計畫提出研發實戰終止申請並核准者。

are having difficult time adapting to the program; they can withdraw from the program if approved by the enterprises and Program Office.

- (3) 承上述情形者，統一由企業向計畫執行團隊提出研發實戰終止申請，研發實戰津貼之計算至研發實戰終止當日，並依研發實戰時數比例核撥。

Termination and Withdrawal application must be submitted to the Program Office by the enterprise. The stipend will be calculated up to the termination date and disbursed proportionally based on the hours completed.

七、計畫重要時程 Program Timeline

作業項目 Subject	預計時程 Timeline
企業申請截止日 Application Deadline for Enterprises	113年3月29日 (五) March 29 th , 2024
企業專題及員額核定結果公告 Project Review Result Announcement	113年4月中旬 Mid-April, 2024
學生申請截止日 Application Deadline for Students	113年5月8日 (三) May 8 th , 2024
各校確認學生推薦名單 University Recommendation	113年5月9日 (四) ~113年5月13日 (一) May 9 th -13 th , 2024
面談/媒合/遞補作業 Interview / Matching / Alternate Section	112年5月14日 (二) ~ 113年6月21日 (五) May 14 th – June 21 st , 2024
企業通知學生完成報到及提交錄取名單 Admission Confirmation	113年6月26日 (三) June 26, 2024
公告錄取名單 Admission Announcement	113年6月底前 Before the end of June, 2024
研發實戰期間 Research and Development Internship	113年7~9月 July to September, 2024
研發實戰發表暨媒合交流活動 End of Program Presentation and Ceremony	113年10~11月 October-November, 2024
國內外研習(暫定) Study Trip (tentative)	113年11月底前 Before the end of November, 2024

八、計畫執行團隊聯絡窗口 Program Office Contact Information

主辦單位：經濟部產業發展署

Host Organization: Industrial Development Administration, MOEA

執行單位 (計畫執行團隊)：台北市電腦商業同業公會

Implementer (Program Office): Taipei Computer Association

計畫聯絡人：林小姐

Contact Person: Ms. Lin

聯絡電話：(02) 2577-4249#462；Email：meihsiu@mail.tca.org.tw

Number: (02) 2577-4249#462；Email：meihsiu@mail.tca.org.tw

計畫網站：<https://www.satcom.org.tw/>

Program Website: <https://www.satcom.org.tw/>

附件一、申請履歷資料

Attachment 1 Application Form

本表格僅提供有意願申請之學生、應屆畢業生準備履歷參考，
正式報名請至計畫網站申請並上傳資料

This form is designed to assist in resume preparation. For the official application process, please visit program website to submit your application and upload required documents.

※基本資料 (必填) Personnel Information (Required)				
姓名 Name		性別 Gender		出生年月日 Date of Birth (yyyy/mm/dd)
手機 Cell phone number		常用 E-mail Email		
身分別 Identity	<input type="checkbox"/> 本國生 Taiwanese Student <input type="checkbox"/> 僑生 Overseas Chinese Student <input type="checkbox"/> 外籍生 International Student		國籍 Nationality	
通訊地址 Address				
※學歷資料 (必填) Education Background (Required)				
就讀學校 University		科系名稱 Department		
就讀年級 Year		語言能力 Language ability		
學 號 Student ID Number		指導老師 Advisor		
※本計畫申請資料 (必填) Program Information (Required)				
參與領域 (可複選) Fields of Interest (Select Multiple)			期望工作地點 (至多 3 項) Preferred Work Locations (Select up to 3)	

※資格審核佐證資料 (必填) Documentation for Qualification Verification (Required)	※能力證明資料 (選填) Additional Documents (Optional)
<p style="text-align: center;">Student ID Card</p>	<ol style="list-style-type: none"> 1. 學校歷年成績單 Academic Transcript 2. 工作經歷 Work Experience 3. E-portfolio 學習履歷 (競賽、得獎記錄、作品、實習或相關工作經驗等) E-Portfolio (including competitions, awards, projects, internships, or relevant work experience) 4. 相關 MOOCs 或實體修課證明 (如實作工作坊、國際培育營等) Certificates for MOOCs or relevant courses (such as workshops or international training camps) 5. 其他 (如畢業證書、錄取通知或役畢/免役證明) Others documents (diploma, admission letters, or military discharge/exemption certificate)
※自傳 (如自我介紹、參與動機與期望) (選填) Biography (Optional) - including self-introduction, motivation for participation, and expectations	